



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

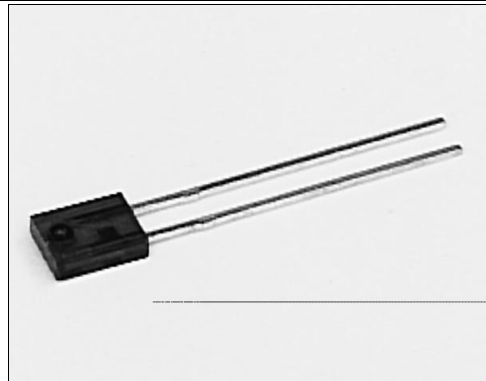


# SEP8506

## GaAs Infrared Emitting Diode

### FEATURES

- Side-emitting plastic package
- 50° (nominal) beam angle
- 935 nm wavelength
- Mechanically and spectrally matched to SDP8406 phototransistor, SDP8106 photodarlington and SDP8000/8600 series Schmitt trigger



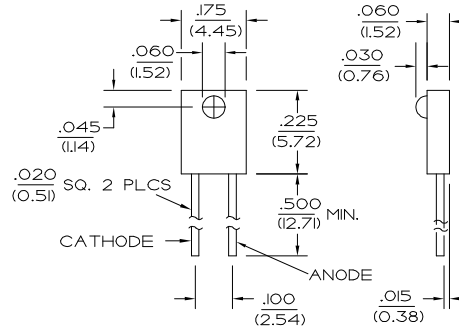
INFRA-20.TIF

### DESCRIPTION

The SEP8506 is a gallium arsenide infrared emitting diode molded in a side-emitting red plastic package. The chip is positioned to emit radiation through a plastic lens from the side of the package.

### OUTLINE DIMENSIONS in inches (mm)

Tolerance 3 plc decimals ±0.005(0.12)  
2 plc decimals ±0.020(0.51)



DIM\_071.d64

# SEP8506

## GaAs Infrared Emitting Diode

### ELECTRICAL CHARACTERISTICS (25°C unless otherwise noted)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	TEST CONDITIONS
Irradiance <sup>(1)</sup>	H				mW/cm <sup>2</sup>	I <sub>F</sub> =20 mA
SEP8506-001		0.05		0.36		
SEP8506-002		0.33		0.52		
SEP8506-003		0.45		0.90		
Forward Voltage	V <sub>F</sub>			1.5	V	I <sub>F</sub> =20 mA
Reverse Breakdown Voltage	V <sub>BR</sub>	3.0			V	I <sub>R</sub> =10 μA
Peak Output Wavelength	λ <sub>p</sub>		935		nm	
Spectral Bandwidth	Δλ		50		nm	
Spectral Shift With Temperature	Δλ <sub>p</sub> /ΔT		0.3		nm/°C	
Beam Angle <sup>(2)</sup>	Ø		50		degr.	I <sub>F</sub> =Constant
Radiation Rise And Fall Time	t <sub>r</sub> , t <sub>f</sub>		0.7		μs	

#### Notes

1. Measured in mW/cm<sup>2</sup> into a 0.104 (2.64) diameter aperture placed 0.535 (13.6) from the lens tip.
2. Beam angle is defined as the total included angle between the half intensity points.

### ABSOLUTE MAXIMUM RATINGS

(25°C Free-Air Temperature unless otherwise noted)

Continuous Forward Current	50 mA
Power Dissipation	100 mW <sup>(1)</sup>
Storage Temperature Range	-40°C to 85°C
Operating Temperature Range	-40°C to 85°C
Soldering Temperature (5 sec)	240°C

#### Notes

1. Derate linearly from 25°C free-air temperature at the rate of 0.78 mW/°C.

### SCHEMATIC



Honeywell reserves the right to make changes in order to improve design and supply the best products possible.

# Honeywell

# SEP8506

## GaAs Infrared Emitting Diode

Fig. 1 Radiant Intensity vs Angular Displacement gra\_030.ds4

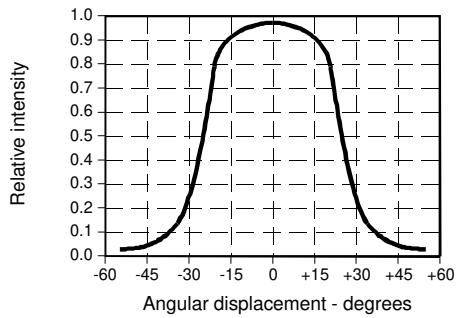


Fig. 2 Radiant Intensity vs Forward Current gra\_028.ds4

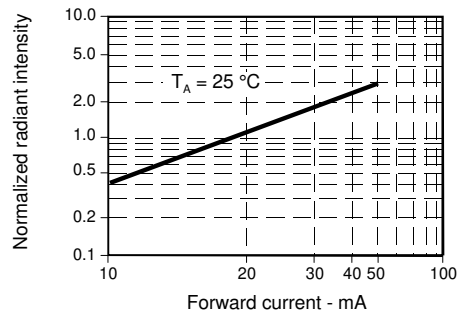


Fig. 3 Forward Voltage vs Forward Current gra\_003.ds4

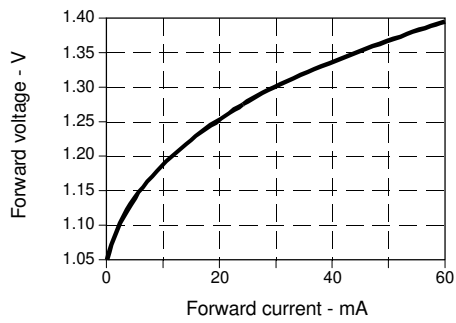


Fig. 4 Forward Voltage vs Temperature gra\_207.ds4

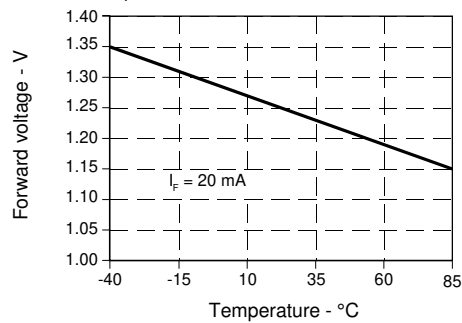


Fig. 5 Spectral Bandwidth gra\_005.ds4

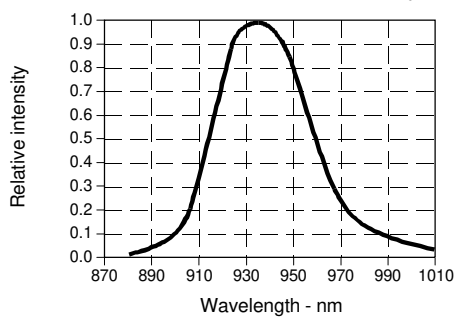
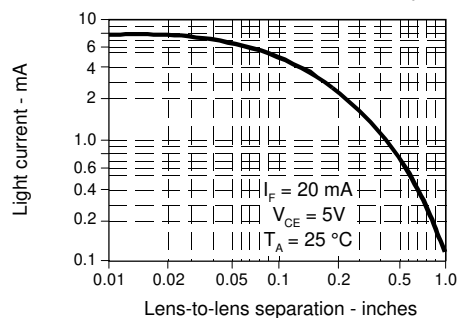
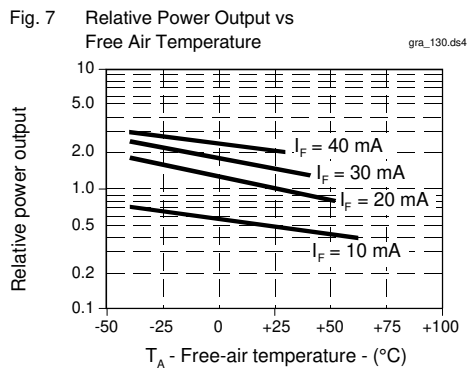


Fig. 6 Coupling Characteristics with SDP8406 gra\_031.ds4



# SEP8506

## GaAs Infrared Emitting Diode



All Performance Curves Show Typical Values